

VUTS010R055NB

Datasheet

VMDSEMI



VUTS010R055NB

General Description

Symbol

V _{(BR)DSS}	R _{DS(ON)_max}	ID
100V	5.5mΩ@10V	130A

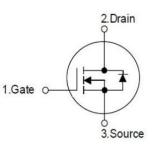
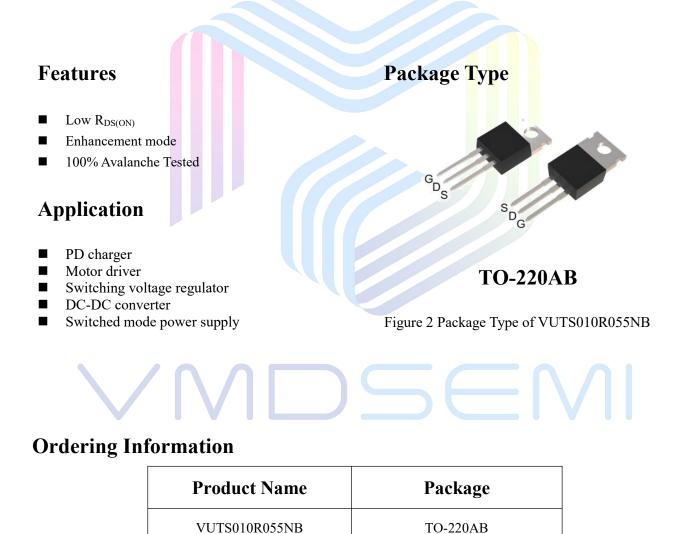


Figure 1 Symbol of VUTS010R055NB





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Absolute Maximum Ratings (T_A= 25 °C, unless otherwise specified)

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage		V _{DSS}	100	V
Gate-Source Voltage		V _{GSS}	±25	V
Continuous Drain Current (Silicon limited)	$T_{C}=25^{\circ}C$		200	
Continuous Drain Current (Wire Bond limited)	$T_{\rm C}=25^{\rm o}{\rm C}$	ID	130	A
Continuous Drain Current (Silicon limited)	T _C =100°C		142	
Pulsed Drain Current ^{Note 2}	$T_C=25^{\circ}C$	I _{D.pulse}	800	A
Continuous Diode Forward Current	Tc=25°C	Is	200	A
Continuous Drain Current	$T_A=25^{\circ}C$	T	15	A
Continuous Drain Current	T _A =70°C	- I _{DSM}	12	A
Max Power Dissipation	$T_c=25^{\circ}C$	PD	375	W
Max Power Dissipation ^{Note 3}	T _A =25°C	P _{DSM}	2	W
Avalanche Energy, Single Pulse Note 4		E _{AS}	900	mJ
Operation and storage temperature		T _J ,T _{STG}	- <mark>5</mark> 5 to 175	°C

Thermal Resistance

Parameter	Symbol	Min	Тур	Max	Unit	
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$		0.4	0.5	9C/W	
Thermal Resistance, Junction-to-Ambient	R _{0JA}		62.5	75	°C/W	

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Parameter		Symbol	Test Conditions	Min	Тур	Max	Unit
Statistic Characteristics							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250uA	100			V
Zero Gate Voltage Drain Current		- I _{DSS}	V _{DS} =100V, V _{GS} =0V			1	uA
Zero Gate Voltage Drain Current T_J = 125 °C			V _{DS} =100V, V _{GS} =0V			100	uA
Gate-Body Leakage Current	Forward	I_{GSSF} $V_{GS}=25V, V_{DS}=0V$				100	
	Reverse	I _{GSSR}	V_{GS} =-25V, V_{DS} =0V			-100	nA
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250uA	2.4	3	3.6	V
Drain-Source On-Resistance ^{Note1}		D			4.5	5.5	mΩ
Drain-Source On-Resistance ^{Note}	1 T _J = 100 °C	$R_{DS(ON)}$ $V_{GS}=10V, I_D=80A$			6.5		
Gate resistance		R _G	f=1 MHz, Open drain	0.2	2.3	5	Ω
Dynamic Characteristics							
Input Capacitance		C _{ISS}	V _{DS} =30V	11065	14755	19625	pF
Output Capacitance		Coss	V _{GS} =0V	<mark>50</mark> 0	665	885	pF
Reverse Transfer Capacitance		C _{RSS}	f=1MHz	370	495	660	pF
Turn-on Delay Time		t _{d(on)}	V _{DS} =50V		35		
Rise Time		tr	I _D =40A		67		ns
Turn-off Delay Time		t _{d(off)}	$R_G=3\Omega$		128		
Fall Time		t _f	V _{GS} =10V		64		
Gate Charge Characteristics					•		
Gate to Source Charge	Gate to Source Charge		V _{GS} =10V		59	78	
Gate to Drain Charge		Q _{gd}	$V_{DS}=50V$		60	90	nC
Gate Charge Total		Qg	I _D =40A		232	309	
Reverse Diode Characteristics							
Drain-Source Diode Forward Voltage		V _{SD}	$V_{GS}=0V, I_{SD}=80A$		0.9	1.2	V
Reverse Recovery Time		t _{rr}	$I_{SD}=40AV_{GS}=0V$		44	88	ns
Reverse Recovery Charge		Qrr	di/dt=100A/us		77	154	nC
Notes:				_			

Electrical Characteristics(T_J= 25 °C, unless otherwise specified)

1. Pulse width \leq 380µs; duty cycle \leq 2%.

2. Repetitive rating; pulse width limited by max junction temperature.

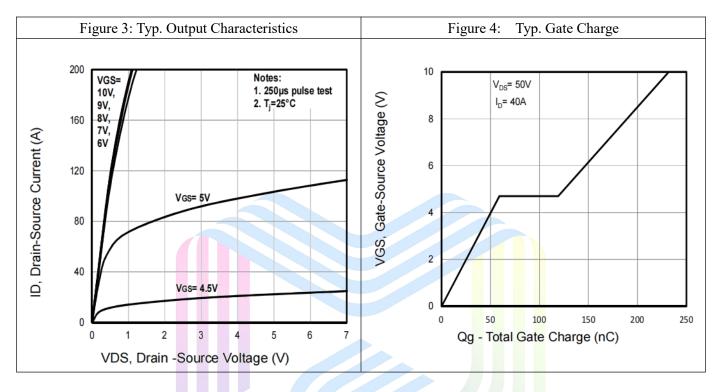
3. The power dissipation P_{DSM} is based on $R_{\theta JA}$ and $@T_J = 125^{\circ}C$

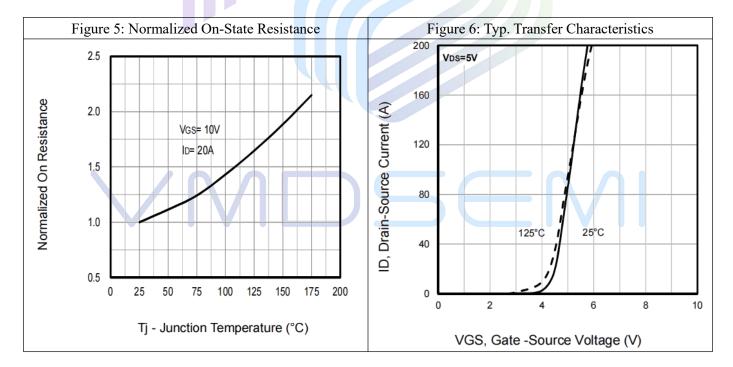
4. Limited by T_{Jmax} , starting $T_J = 25^{\circ}C$, L = 0.5mH, $R_G = 25\Omega$, $I_{AS} = 60A$, $V_{GS} = 10V$.



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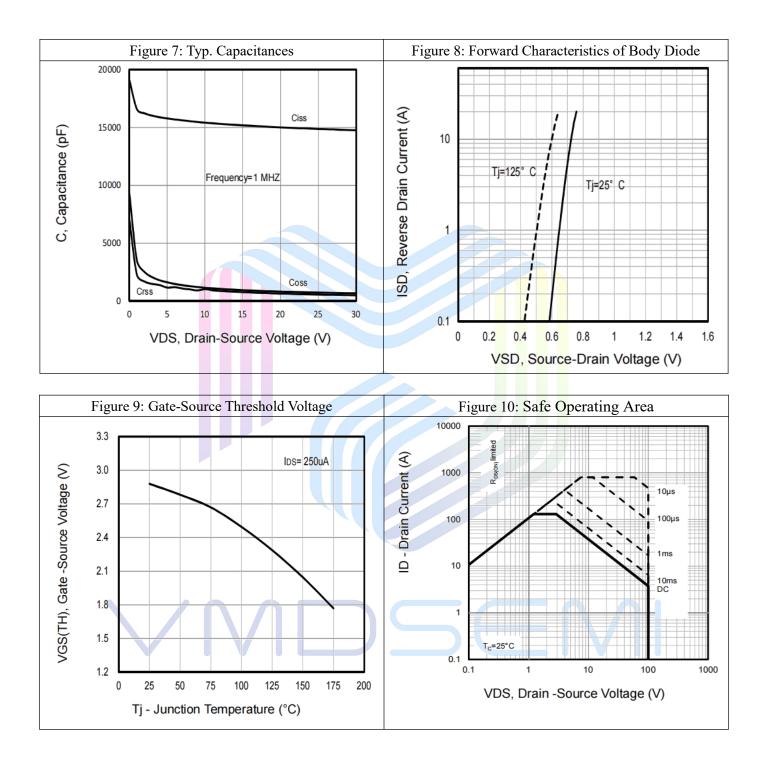
Typical Performance Characteristics





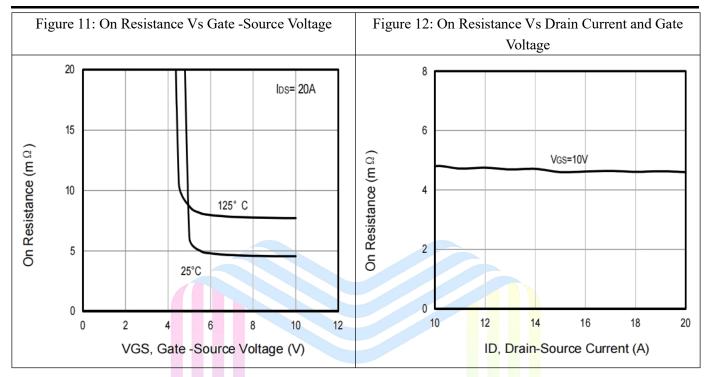


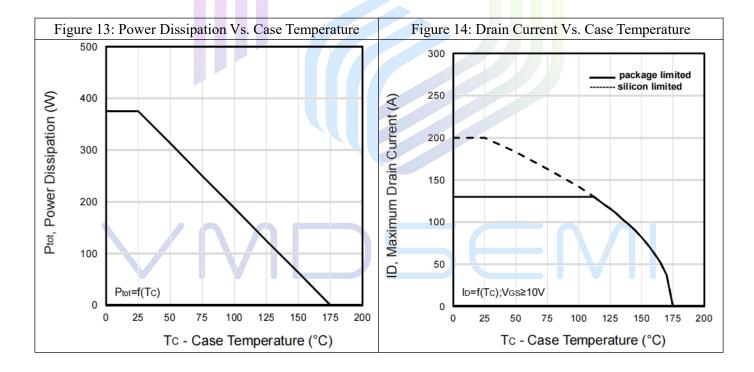
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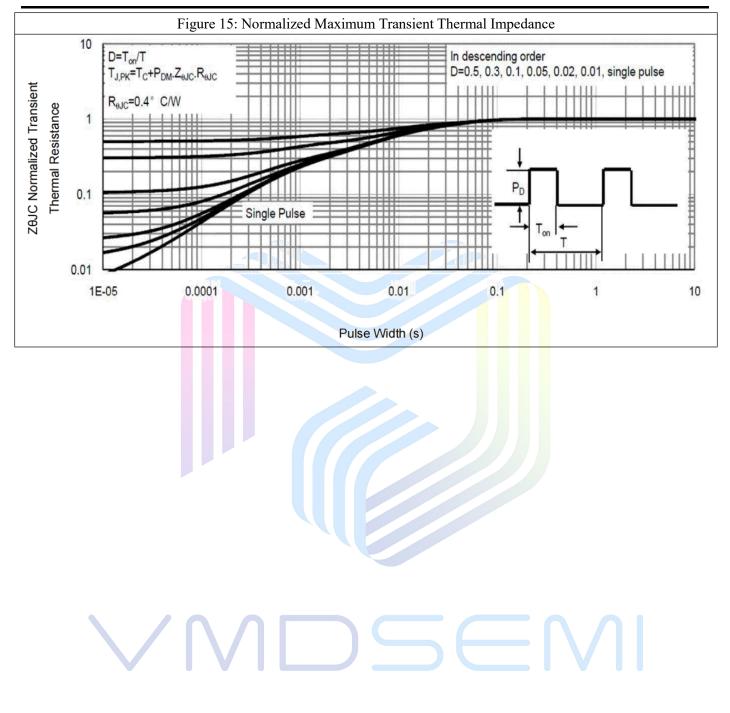
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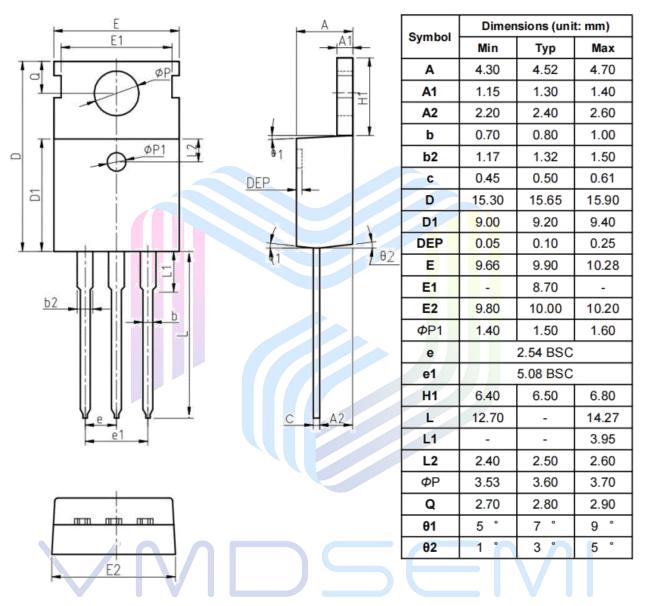




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Mechanical Dimensions

Package Information TO-220AB



Notes:

- 1. Refer to JEDEC TO-220 variation AB
- 2. Dimension "D" and "E" do NOT include mold flash. Mold flash shall not exceed 0.127mm per side.



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